

FERD30M45C

ST advanced rectifier

Datasheet - production data

Features

- Advanced rectifier proprietary process
- Stable leakage current over reverse voltage
- Low forward voltage drop
- High frequency operation

Description

This dual center tap field effect rectifier provides stable leakage current over the full range of reverse voltage and low forward voltage drop.

Packaged in TO-220AB or D²PAK, this device is intended to be used in solar bypass junction boxes and in switch mode power supplies.

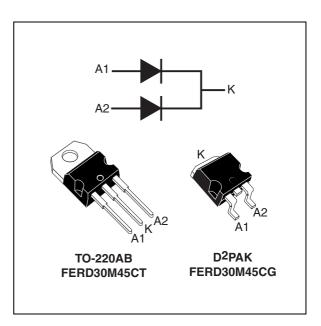


Table 1. Device summary

| Symbol | Value |
|----------------------|--------------------------------------|
| I _{F(AV)} | 2 x 15 A |
| V_{RRM} | 45 V |
| T _{j (max)} | +175 °C up to 200 °C forward mode |
| V _F (typ) | 0.35 V |

Characteristics FERD30M45C

1 Characteristics

Table 2. Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

| Symbol | Parameter | | | Value | Unit |
|---------------------|---|-------------------------|------------|--------------|------|
| V _{RRM} | Repetitive peak reverse voltage | | | 45 | V |
| I _{F(RMS)} | Forward rms current | | | 30 | Α |
| 1 | $I_{F(AV)}$ Average forward current, $\delta = 0.5$ | T _c = 155 °C | Per diode | 15 | Α |
| 'F(AV) | | $T_c = 155$ °C | Per device | 30 | |
| I _{FSM} | Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$ | | | 250 | Α |
| T _{stg} | Storage temperature range | | | -65 to + 175 | °C |
| T _j | Maximum operating junction temperature | | | 175 | °C |
| T _j | Maximum operating temperature (DC forward current without reverse bias, $t = 1 \text{ hour})^{(1)}$ | | 200 | °C | |

 $^{1. \}quad \frac{dPtot}{dTj} < \frac{1}{Rth(j-a)} \ condition \ to \ avoid \ thermal \ runaway \ for \ a \ diode \ on \ its \ own \ heatsink.$

Table 3. Thermal resistance

| Symbol | Parameter | Value (max) | Unit | |
|----------------------|------------------|-------------|------|------|
| D | Junction to case | er diode | 1.6 | |
| R _{th(j-c)} | | otal | 1.05 | °C/W |
| R _{th(c)} | Coupling | | 0.5 | |

When diodes 1 and 2 are used simultaneously:

 $T_j(diode\ 1) = P(diode\ 1)\ x\ R_{th(j-c)}(per\ diode) + P(diode\ 2)\ x\ R_{th}(c)$

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| Table 4. | Static electrical | characteristics (| (per diode) |
|----------|-------------------|-------------------|-------------|
|----------|-------------------|-------------------|-------------|

| Symbol | Parameter | Test conditions | | Min. | Тур. | Max. | Unit |
|-------------------------------|--|-------------------------|------------------------|------|-------|-------|------|
| I _B ⁽¹⁾ | Reverse leakage current | T _j = 25 °C | V - V | | | 600 | μΑ |
| 'R` ′ | IR' / neverse leakage current | T _j = 125 °C | $V_R = V_{RRM}$ | | 25 | 50 | mA |
| | V _F ⁽²⁾ Forward voltage drop | T _j = 125 °C | I _F = 7.5 A | | 0.305 | 0.350 | V |
| V (2) | | T _j = 125 °C | I _F = 10 A | | 0.350 | 0.395 | V |
| V _F ` ′ | | T _j = 25 °C | L _ 15 A | | 0.420 | 0.470 | |
| | | T _j = 125 °C | I _F = 15 A | | 0.420 | 0.450 | |

- 1. Pulse test: $t_p = 5$ ms, $\delta < 2\%$
- 2. Pulse test: t_p = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 0.27 \text{ x } I_{F(AV)} + 0.012 I_{F(RMS)}^{2}$$

Figure 1. Average forward power dissipation Figure 2. versus average forward current (per diode)

Average forward current versus ambient temperature (δ = 0.5, per diode)

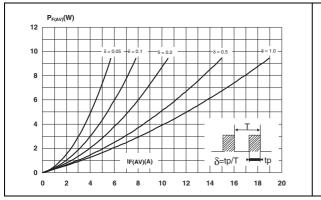
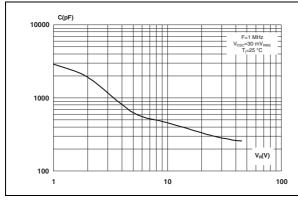
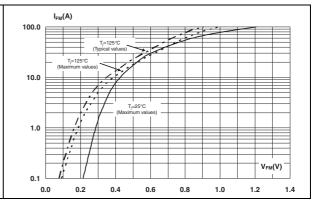


Figure 3. Junction capacitance versus reverse voltage applied (typical values, per diode)

Figure 4. Forward voltage drop versus forward current (per diode)





Characteristics FERD30M45C

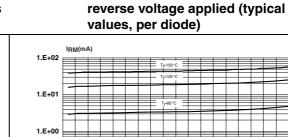
Figure 6.

1.E-01

1.E-02

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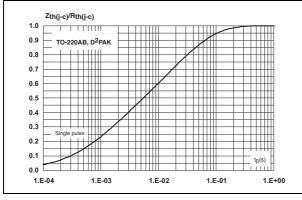
Figure 5. Relative variation of thermal impedance junction to case versus pulse duration



10 15 20 25 30 35

Reverse leakage current versus

40 45



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FERD30M45C Package information

2 Package information

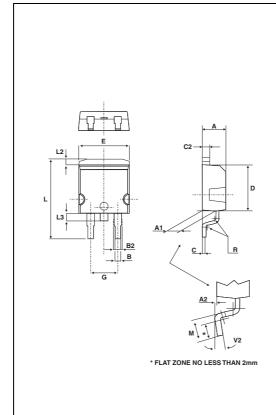
Epoxy meets UL94, V0

Cooling method: by conduction (C)

Recommended torque value: 0.8 to 1.0 N⋅m

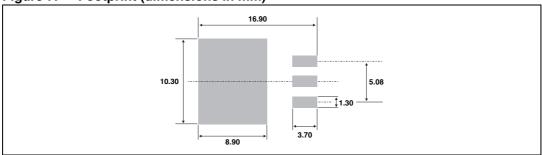
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. D²PAK dimensions



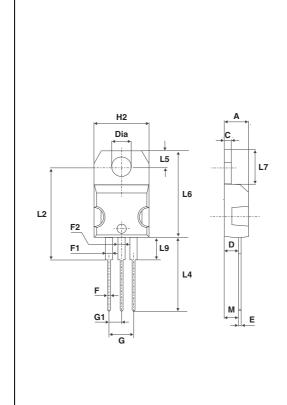
| | Dimensions | | | | |
|------|-------------|-------|-------|--------|--|
| Ref. | Millimeters | | Inc | hes | |
| | Min. | Max. | Min. | Max. | |
| Α | 4.40 | 4.60 | 0.173 | 0.181 | |
| A1 | 2.49 | 2.69 | 0.098 | 0.106 | |
| A2 | 0.03 | 0.23 | 0.001 | 0.009 | |
| В | 0.70 | 0.93 | 0.027 | 0.037 | |
| B2 | 1.14 | 1.70 | 0.045 | 0.067 | |
| С | 0.45 | 0.60 | 0.017 | 0.024 | |
| C2 | 1.23 | 1.36 | 0.048 | 0.054 | |
| D | 8.95 | 9.35 | 0.352 | 0.368 | |
| Е | 10.00 | 10.40 | 0.393 | 0.409 | |
| G | 4.88 | 5.28 | 0.192 | 0.208 | |
| L | 15.00 | 15.85 | 0.590 | 0.624 | |
| L2 | 1.27 | 1.40 | 0.050 | 0.055 | |
| L3 | 1.40 | 1.75 | 0.055 | 0.069 | |
| М | 2.40 | 3.20 | 0.094 | 0.126 | |
| R | 0.40 typ. | | 0.010 | 6 typ. | |
| V2 | 0° | 8° | 0° | 8° | |

Figure 7. Footprint (dimensions in mm)



Package information FERD30M45C

Table 6. TO-220AB dimensions



| | Dimensions | | | | |
|-------|-------------|-------|------------|--------|--|
| Ref. | Millimeters | | Inc | hes | |
| | Min. | Max. | Min. | Max. | |
| Α | 4.40 | 4.60 | 0.173 | 0.181 | |
| С | 1.23 | 1.32 | 0.048 | 0.051 | |
| D | 2.40 | 2.72 | 0.094 | 0.107 | |
| Е | 0.49 | 0.70 | 0.019 | 0.027 | |
| F | 0.61 | 0.88 | 0.024 | 0.034 | |
| F1 | 1.14 | 1.70 | 0.044 | 0.066 | |
| F2 | 1.14 | 1.70 | 0.044 | 0.066 | |
| G | 4.95 | 5.15 | 0.194 | 0.202 | |
| G1 | 2.40 | 2.70 | 0.094 | 0.106 | |
| H2 | 10 | 10.40 | 0.393 | 0.409 | |
| L2 | 16.4 | typ. | 0.645 typ. | | |
| L4 | 13 | 14 | 0.511 | 0.551 | |
| L5 | 2.65 | 2.95 | 0.104 | 0.116 | |
| L6 | 15.25 | 15.75 | 0.600 | 0.620 | |
| L7 | 6.20 | 6.60 | 0.244 | 0.259 | |
| L9 | 3.50 | 3.93 | 0.137 | 0.154 | |
| М | 2.6 | typ. | 0.102 | 2 typ. | |
| Diam. | 3.75 | 3.85 | 0.147 | 0.151 | |

3 Ordering information

Table 7. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|----------------|-------------|--------------------|--------|----------|---------------|
| FERD30M45CT | FERD30M45CT | TO-220AB | 2.2 g | 50 | Tube |
| FERD30M45CG-TR | FERD30M45CG | D ² PAK | 1.5 g | 1000 | Tape and reel |

4 Revision history

Table 8. Document revision history

| Date | Revision | Changes |
|-------------|----------|------------------|
| 12-Nov-2012 | 1 | Initial release. |

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